

## N-CHANNEL SILICON POWER MOSFET

## FAP-IIA SERIES

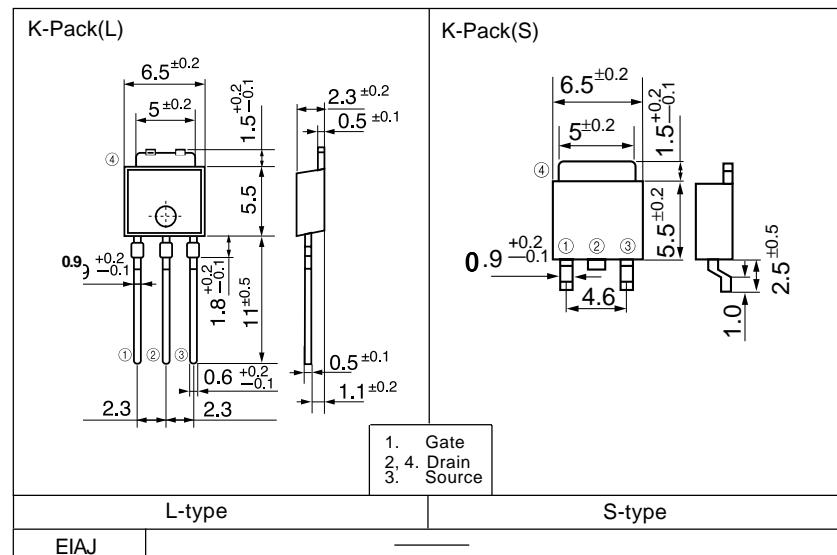
### ■ Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- High voltage
- $V_{GS} = \pm 30V$  Guarantee
- Avalanche-proof

### ■ Applications

- Switching regulators
- UPS
- DC-DC converters
- General purpose power amplifier

### ■ Outline Drawings

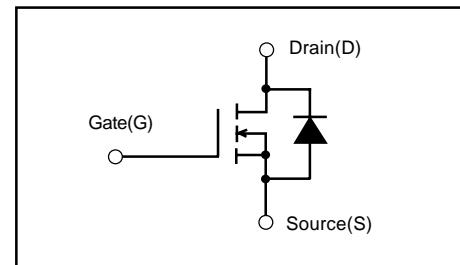


### ■ Maximum ratings and characteristics

#### ● Absolute maximum ratings ( $T_c=25^\circ\text{C}$ unless otherwise specified)

Item	Symbol	Rating	Unit
Drain-source voltage	$V_{DS}$	250	V
Continuous drain current	$I_D$	6	A
Pulsed drain current	$I_{D(\text{puls})}$	24	A
Continuous reverse drain current	$I_{DR}$	6	A
Gate-source peak voltage	$V_{GS}$	$\pm 30$	V
Max. power dissipation	$P_D$	20	W
Operating and storage temperature range	$T_{ch}$	+150	$^\circ\text{C}$
	$T_{stg}$	-55 to +150	$^\circ\text{C}$

### ■ Equivalent circuit schematic



#### ● Electrical characteristics ( $T_c = 25^\circ\text{C}$ unless otherwise specified)

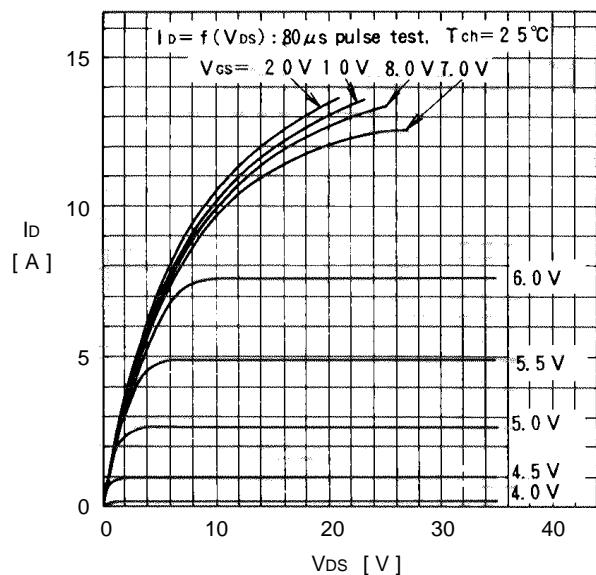
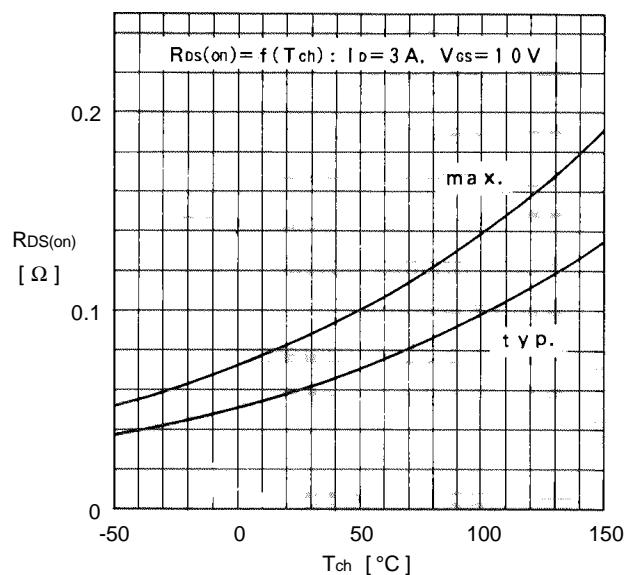
Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D=1\text{mA}$ $V_{GS}=0\text{V}$	250			V
Gate threshold voltage	$V_{GS(\text{th})}$	$I_D=1\text{mA}$ $V_{DS}=V_{GS}$	2.5	3.0	3.5	V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS}=250\text{V}$ $V_{GS}=0\text{V}$	10	500	500	$\mu\text{A}$
		$T_{ch}=25^\circ\text{C}$	0.2	1.0	1.0	mA
Gate-source leakage current	$I_{GSS}$	$V_{GS}=\pm 30\text{V}$ $V_{DS}=0\text{V}$	10	100	100	nA
Drain-source on-state resistance	$R_{DS(\text{on})}$	$I_D=3\text{A}$ $V_{GS}=10\text{V}$		0.6	0.85	$\Omega$
Forward transconductance	$G_{fs}$	$I_D=3\text{A}$ $V_{DS}=25\text{V}$	1.5	3.0		S
Input capacitance	$C_{iss}$	$V_{DS}=25\text{V}$	400	600		
Output capacitance	$C_{oss}$	$V_{GS}=0\text{V}$	75	110		
Reverse transfer capacitance	$C_{rss}$	$f=1\text{MHz}$	20	30		pF
Turn-on time $t_{on}$	$t_{d(on)}$	$V_{CC}=150\text{V}$ $R_G=10\ \Omega$	20	30		
( $t_{on}=t_{d(on)}+t_r$ )	$t_r$	$I_D=6\text{A}$	20	30		
Turn-off time $t_{off}$	$t_{d(off)}$	$V_{GS}=10\text{V}$	40	60		
( $t_{off}=t_{d(off)}+t_f$ )	$t_f$		10	15		ns
Avalanche capability	$I_{AV}$	$L=100\mu\text{H}$ $T_{ch}=25^\circ\text{C}$	6			A
Diode forward on-voltage	$V_{SD}$	$I_F=2 \times I_{DR}$ $V_{GS}=0\text{V}$ $T_{ch}=25^\circ\text{C}$		1.0	1.5	V
Reverse recovery time	$t_{rr}$	$I_F=I_{DR}$ $V_{GS}=0\text{V}$	120			ns
Reverse recovery charge	$Q_{rr}$	$-di/dt=100\text{A}/\mu\text{s}$ $T_{ch}=25^\circ\text{C}$		0.6		$\mu\text{C}$

#### ● Thermal characteristics

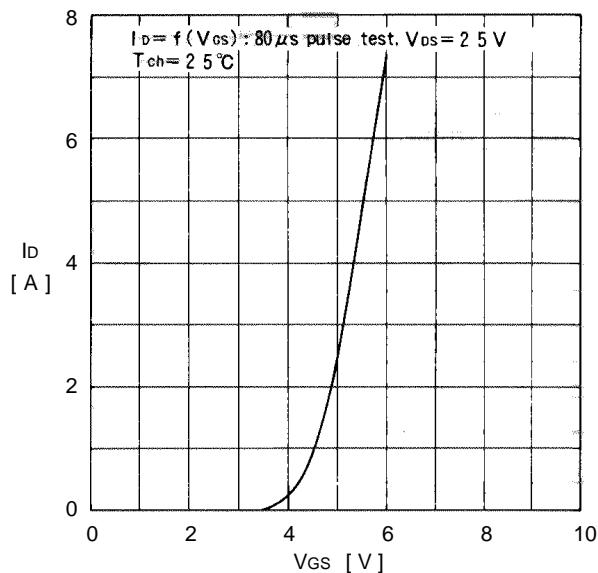
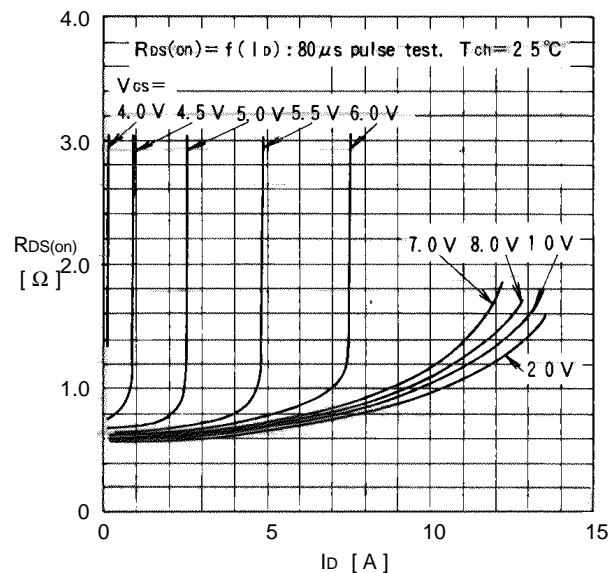
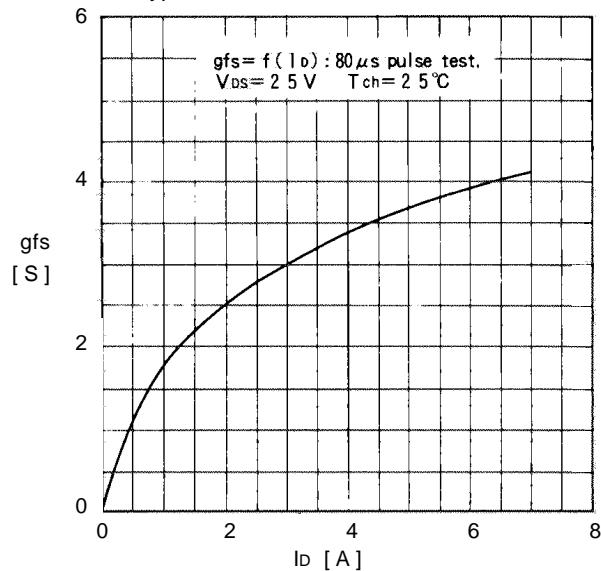
Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	$R_{th(ch-a)}$	channel to ambient				$^\circ\text{C/W}$
	$R_{th(ch-c)}$	channel to case			6.25	$^\circ\text{C/W}$

## ■ Characteristics

Typical output characteristics

On state resistance vs.  $T_{ch}$ 

Typical transfer characteristics

Typical Drain-Source on state resistance vs.  $I_D$ Typical forward transconductance vs.  $I_D$ Gate threshold voltage vs.  $T_{ch}$ 